

N-Channel Enhancement Mode MOSFET

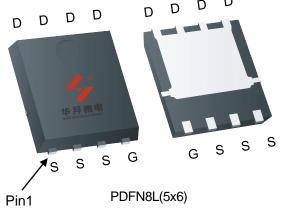
Feature

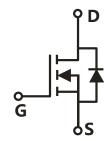
- 100V/180A $R_{DS(ON)} = 2.7 \text{ m}\Omega(typ.) @VGS = 10V$
- 100% Avalanche Tested
- 100% DVDS
- Reliable and Rugged
- Halogen Free and Green Devices Available (RoHS Compliant)

Applications

- Power Delivery
- Li-battery protection
- DC-DC
- Motor control

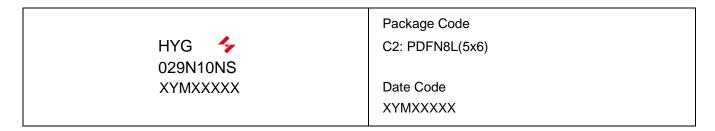
Pin Description





Single N-Channel MOSFET

Ordering and Marking Information



Note: HUAYI halogen free products contain molding compounds and 100% matter tin plate Termi-Nation finish; which are fully compliant with RoHS. HUAYI halogen free products meet or exceed the halogen free require-ments of IPC/JEDEC J-STD-020 for MSL classification at halogen free peak reflow temperature. HUAYI defines "Green" to mean halogen free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

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Absolute Maximum Ratings

| Symbol | Parameter | Rating | Unit | |
|------------------|---|----------|------------|------|
| Common Ra | ntings (Tc=25°C Unless Otherwise Noted) | | | |
| VDSS | Drain-Source Voltage | | 100 | V |
| Vgss | Gate-Source Voltage | | ±20 | V |
| TJ | Junction Temperature Range | | | °C |
| Тѕтс | Storage Temperature Range | | -55 to 175 | °C |
| ls | Source Current-Continuous(Body Diode) | Tc=25°C | 180 | А |
| Mounted on | Large Heat Sink | | • | |
| Ірм | Pulsed Drain Current * | Tc=25°C | 645 | А |
| | Continuous Danie Comment | Tc=25°C | 180 | А |
| lo | Continuous Drain Current | Tc=100°C | 127 | Α |
| | P _D Maximum Power Dissipation Tc | | 231 | W |
| PD | | | 116 | W |
| R₀ıc | Thermal Resistance, Junction-to-Case | | 0.65 | °C/W |
| R _{eJA} | Thermal Resistance, Junction-to-Ambient ** | | 80 | °C/W |
| Eas | Single Pulsed-Avalanche Energy *** L=0.3mH | | 622 | mJ |

Note:

- * Repetitive rating; pulse width limited by max.junction temperature.
- ** Surface mounted on 1in2 FR-4 board.
- *** Limited by TJmax , starting TJ=25°C, L = 0.3mH, Rg= 25Ω , Vgs =10V.

Electrical Characteristics(Tc =25°C Unless Otherwise Noted)

| Cymbal | Dorometer | Test Conditions | HYG029N10NS1 | | Unit | | |
|-------------|----------------------------------|---|--------------|------|------|-------|--|
| Symbol | Parameter | rest Conditions | Min | Тур. | Max | Offic | |
| Static Char | Static Characteristics | | | | | | |
| BVDSS | Drain-Source Breakdown Voltage | V _{GS} =0V,I _{DS} =250μA | 100 | - | - | V | |
| Ipss | VDS=100V,VGS=0V | | - | - | 1 | μΑ | |
| IDSS | Drain-to-Source Leakage Current | TJ=125°C | - | - | 50 | μA | |
| VGS(th) | Gate Threshold Voltage | V _{DS} =V _{GS} , I _{DS} =250µA | 2 | 3 | 4 | V | |
| Igss | Gate-Source Leakage Current | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ±100 | nA | |
| RDS(ON) | Drain-Source On-State Resistance | V _{GS} =10V,I _{DS} =50A | - | 2.7 | 3.6 | mΩ | |
| Diode Char | Diode Characteristics | | | | | | |
| VsD | Diode Forward Voltage | IsD=50A,Vgs=0V | - | 0.85 | 1.3 | V | |
| trr | Reverse Recovery Time | Isp=50A,dIsp/dt=100A/µs | - | 65 | - | ns | |
| Qrr | Reverse Recovery Charge | 15D-30A, u15D/U1=100A/µ5 | - | 110 | - | nC | |

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Electrical Characteristics (Cont.) (Tc =25°C Unless Otherwise Noted)

| O. wala al | Damamastan | Tool Conditions | HYG029N10I | | | |
|-----------------------------|---|--|------------|------|-----|------|
| Symbol Parameter | | Test Conditions | Min | Тур. | Max | Unit |
| Dynamic | Dynamic Characteristics | | | | | |
| Rg | Gate Resistance | V _{GS} =0V,V _{DS} =0V,F=500KHz | - | 1.2 | - | Ω |
| Ciss | Input Capacitance | Vgs=0V, | - | 5640 | - | |
| Coss | Output Capacitance | V _{DS} =25V, | - | 2172 | - | pF |
| Crss | Reverse Transfer Capacitance | Frequency=500KHz | - | 149 | - | |
| td(ON) | Turn-on Delay Time | | - | 19 | - | |
| Tr | Turn-on Rise Time | V _{DD} =50V,R _G =2.5Ω, | - | 60 | - | |
| t d(OFF) | Turn-off Delay Time | Ips=50A,Vgs=10V | - | 43 | - | ns |
| Tf | Turn-off Fall Time | | - | 61 | - | |
| Gate Charge Characteristics | | | | | | |
| Qg | Total Gate Charge(V _{GS} =10V) | | - | 86 | - | |
| Qgs | Gate-Source Charge | V 90V I 50A | - | 30 | - | nC |
| Qgd | Gate-Drain Charge | V_{DS} =80V, I_{DS} =50A | - | 17 | - | |
| V _{plateau} | Gate plateau voltage | | - | 4.9 | - | V |

Note: *Pulse test, pulse width ≤ 300 us, duty cycle $\leq 2\%$



Typical Operating Characteristics

Figure 1: Power Dissipation

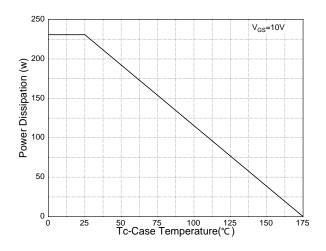


Figure 3: Safe Operation Area

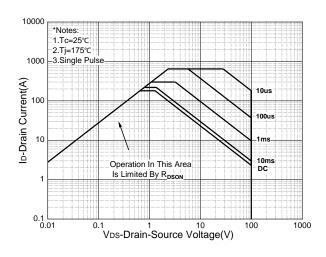


Figure 5: Output Characteristics

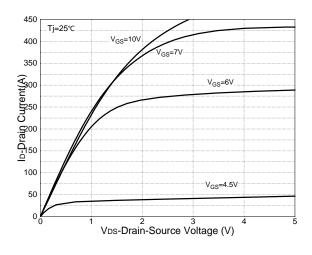


Figure 2: Drain Current

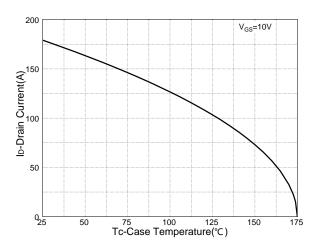


Figure 4: Thermal Transient Impedance

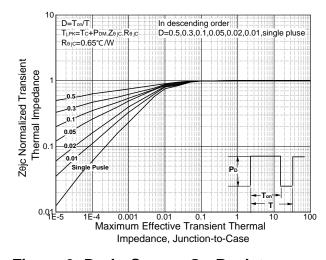
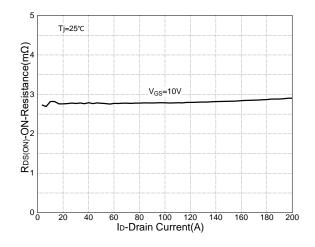


Figure 6: Drain-Source On Resistance





Typical Operating Characteristics(Cont.)

Figure 7: On-Resistance vs. Temperature

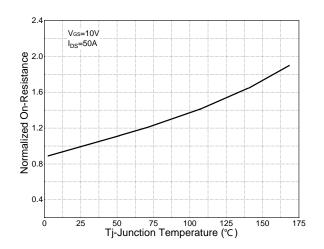


Figure 8: Source-Drain Diode Forward

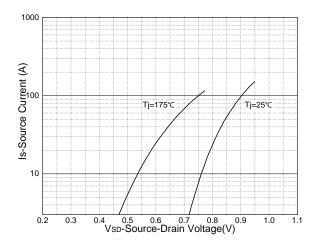


Figure 9: Capacitance Characteristics

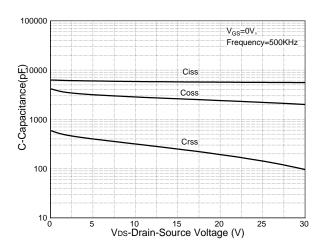
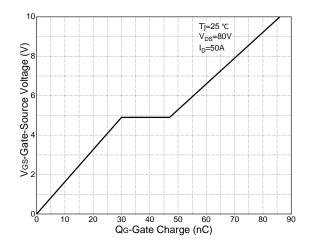
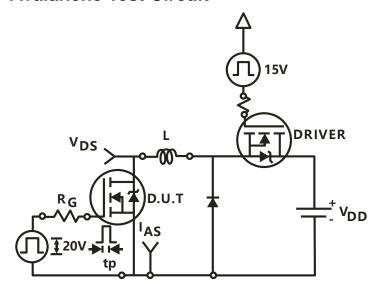


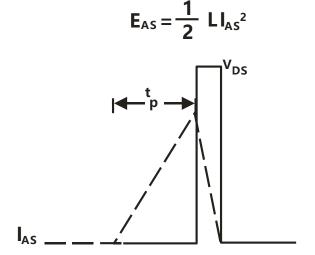
Figure 10: Gate Charge Characteristics



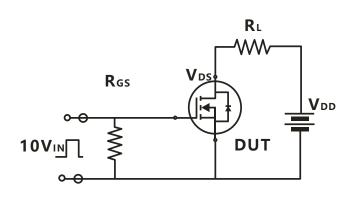


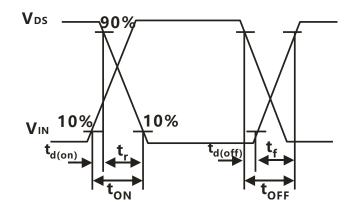
Avalanche Test Circuit



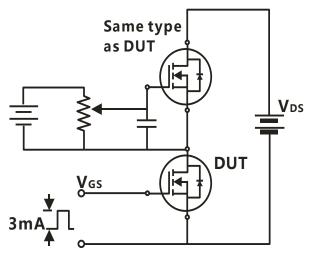


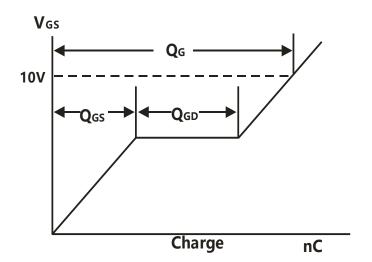
Switching Time Test Circuit





Gate Charge Test Circuit







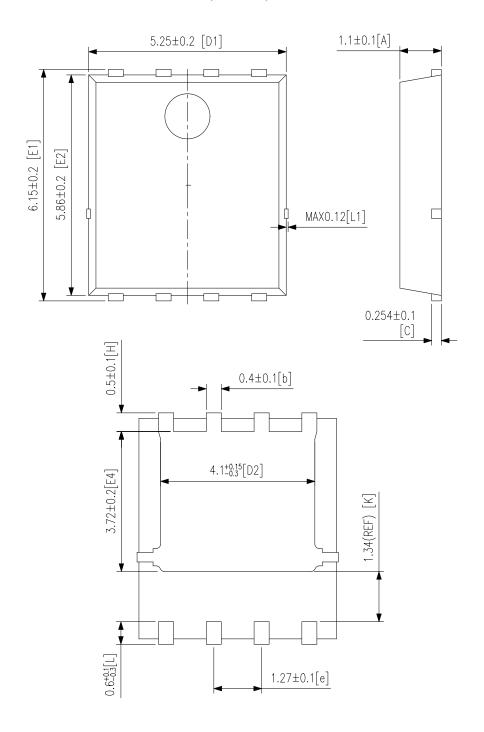
Device Per Unit

| Package Type | Unit | Quantity |
|--------------|------|----------|
| PDFN8L(5x6) | Reel | 5000 |

Package Information

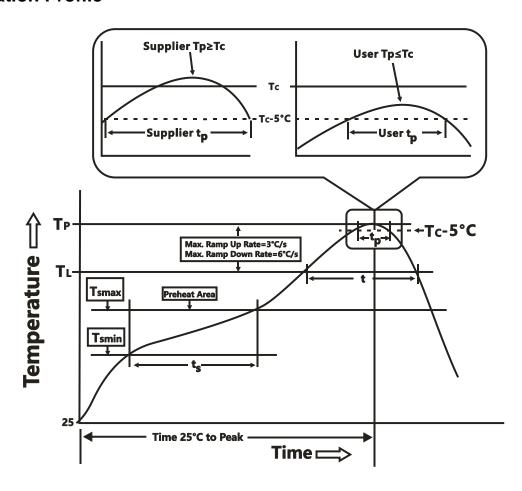
PDFN8L(5x6)

(unit:mm)





Classification Profile



Classification Reflow Profiles

| Profile Feature | Sn-Pb Eutectic Assembly | Pb-Free Assembly | | | |
|--|------------------------------------|----------------------------------|--|--|--|
| Preheat & Soak | | | | | |
| Temperature min (T _{smin}) | 100 °C | 150 °C | | | |
| Temperature max (T _{smax}) | 150 °C | 200 °C | | | |
| Time (Tsmin to Tsmax) (t _s) | 60-120 seconds | 60-120 seconds | | | |
| Average ramp-up rate | 3 °C/second max. | 3°C/second max. | | | |
| (T _{smax} to T _P) | 5 C/second max. | | | | |
| Liquidous temperature (T _L) | 183 °C | 217 °C | | | |
| Time at liquidous (t _L) | 60-150 seconds | 60-150 seconds | | | |
| Peak package body Temperature | See Classification Temp in table 1 | SeeClassification Tempin table 2 | | | |
| (T _p)* | See Classification Temp in table 1 | | | | |
| Time (t _P)** within 5°C of the specified | 20** | 30** seconds | | | |
| classification temperature (T _c) | 20** seconds | | | | |
| Average ramp-down rate (Tpto Tsmax) | 6 °C/second max. | 6 °C/second max. | | | |
| Time 25°C to peak temperature | 6 minutes max. | 8 minutes max. | | | |

^{*}Tolerance for peak profile Temperature (Tp) is defined as a supplier minimum and a user maximum.

^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

| Package Thickness | Volume mm³ <350 | Volume mm³ ≥350 |
|----------------------|--------------------|--------------------|
| <2.5 mm | 235 °C | 220 °C |
| ≥2.5 mm | 220 °C | 220 °C |

Table 2.Pb-free Process – Classification Temperatures (Tc)

| Package | Volume mm ³ | Volume mm ³ | Volume mm³ |
|-----------------|------------------------|------------------------|------------|
| Thickness | <350 | 350-2000 | ≥2000 |
| <1.6 mm | 260 °C | 260 °C | 260 °C |
| 1.6 mm – 2.5 mm | 260 °C | 250 °C | 245 °C |
| ≥2.5 mm | 250 °C | 245 °C | 245 °C |

Reliability Test Program

| Test item | Method | Description |
|---------------|---------------|------------------------------------|
| SOLDERABILITY | JESD-22, B102 | 5 Sec, 245°C |
| HTRB | JESD-22, A108 | 168 /500/1000 Hrs, Bias @ 150°C |
| HTGB | JESD-22, A108 | 168 /500/1000 Hrs, Vgs100% @ 150°C |
| PCT | JESD-22, A102 | 96 Hrs, 100%RH, 2atm, 121°C |
| ТСТ | JESD-22, A104 | 250/500/1000 Cycles, -55°C~150°C |

Customer Service

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